



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

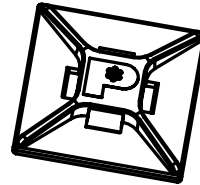
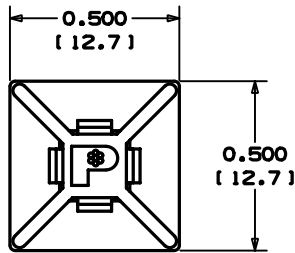
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



THIS COPY IS PROVIDED ON A RESTRICTED BASIS AND IS NOT TO BE USED IN ANY WAY DETRIMENTAL TO THE INTERESTS OF PANDUIT CORP.

NO WARRANTY, EXPRESSED OR IMPLIED, IS MADE BY PANDUIT WITH RESPECT TO ADHESIVE BOND PERFORMANCE. AMONG OTHER THINGS, THE CONDITIONS UNDER WHICH THESE MOUNTS MAY BE APPLIED AND/OR THE SURFACE TO WHICH THEY MAY BE APPLIED ARE BEYOND PANDUIT'S CONTROL.

PANDUIT PART NUMBER*	WEIGHT lbs/100 pcs [g]/100 pcs
ABM1M-A	0.05 [23]

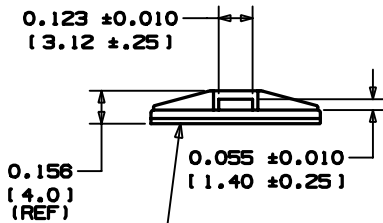


TO APPLY MOUNTS:

- 1) REMOVE MOUNT FROM PROTECTIVE LINER.
- 2) PLACE IN DESIRED LOCATION.
- 3) APPLY PRESSURE TO TOP SURFACE OF MOUNT.

NOTES:

- *1. SEE CURRENT PRICE SHEET FOR PART NUMBER SUFFIX DESIGNATION FOR MATERIAL, COLOR, AND PACKAGE SIZE.
2. USE MOUNTS WITH ONLY MINIATURE CABLE TIE CROSS SECTIONS.
3. MOUNTS ARE SUPPLIED IN STRIPS OF FOUR.
4. MOUNT HAS A CONTINUOUS OPERATING TEMPERATURE OF 120°F (49°C).



ACTUAL SIZE

ADHESIVE BACKING:
PRESSURE SENSITIVE FOAM TAPE
0.040 (1.0) THICK WITH PROTECTIVE
LINER. MOUNT IS DESIGNED TO
SUPPORT 0.13 lbs. (59 g) MAX. WEIGHT
ON A CLEAN, DRY, SMOOTH, GREASE-
FREE SURFACE.

DIMENSIONS IN BRACKETS ARE METRIC [mm]

CAD FILENAME/LAYER G00239DC_PB_ABM1M_A_03



CORP. TINLEY PARK, ILLINOIS

ABM1M-A
ADHESIVE BACKED MOUNT

REV	DATE	BY	CHK	DESCRIPTION	ECN - R	CUST	SUP
3	3/23/05	TMSA		REVISED DIMENSION .123 FROM .120 UPDATED LEADER LINE FOR DIMENSION 0.055	GB0239DC	3	
2	3/29/04	JAD		UPDATE 3D GEOMETRY, AND NOTE 1	GB0239DC	2	
1	10-28-00	CGSM		CHANGED .156 DIMENSION TO REF ADDED NOTE 4	GB0239DC	1	
R	5/15/98	CJG		INITIAL RELEASE	GB0239DC	R	

UNLESS OTHERWISE SPECIFIED,
DIMENSIONAL TOLERANCES ARE:
(.X) ±0.05 (1.3) (,.XXX) ±0.010 (0.25)
(.XX) ±0.02 (0.5) ANGLES ± 5°

UNLESS OTHERWISE SPECIFIED,
ALL DIMENSIONS ARE GIVEN
IN INCHES, THIRD ANGLE PROJECTION.

DRAWN BY CJG

MAT'L:

SCALE NONE

DATE 5/15/98

WHITE
NYLON 6/6

DRAWING NO.

GB0239DC

DWG

A
SIZE